54F132,74F132

Quad 2-Input NAND Schmitt Trigger



Literature Number: SNOS151A

DSXXX

54F/74F132 **Quad 2-Input NAND Schmitt Trigger**

General Description

Features

- Guaranteed 4000V minimum ESD protection
- Standard Military Drawing (SMD)
- 5962-89487

Ordering Code: See Section 0

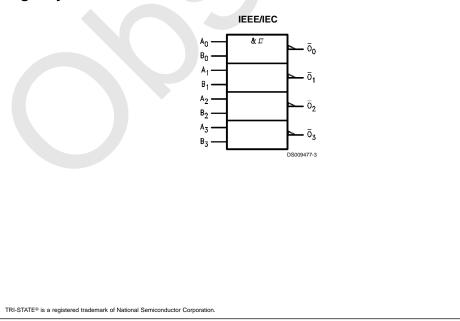
54F/74F132 Quad 2-Inp General Desc The 'F132 contains for standard TTL input sign levels. They are capab put signals into sharply addition, they have a gi NAND gates. Each circuit contains a level shifting circuity a ture. The Schmitt trigge	out NAND Sc	hmitt T hich accept TTL output hanging in- signals. In ponventional ollowed by ttput struc- effectively	
	9 [•] Soo Soction ()		
Ordering Cod		-	
Ordering Cod	Military	Package Number	Package Description
			Package Description 14-Lead (0.300" Wide) Molded Dual-In-Line
Commercial		Number	
Commercial	Military	Number N14A	14-Lead (0.300" Wide) Molded Dual-In-Line
Commercial 74F132PC	Military	NumberN14AJ14A	14-Lead (0.300" Wide) Molded Dual-In-Line 14-Lead Ceramic Dual-In-Line
Commercial 74F132PC 74F132SC (Note 1)	Military	NumberN14AJ14AM14A	14-Lead (0.300" Wide) Molded Dual-In-Line 14-Lead Ceramic Dual-In-Line 14-Lead (0.150" Wide) Molded Small Outline, JEDEC

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Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbol



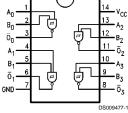
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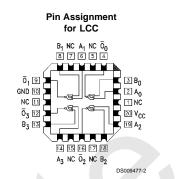
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Connection Diagrams

Pin Assignment for DIP, SOIC and Flatpak

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Unit Loading/Fan Out See Section 0 for U.L. definitions

		5	54F/74F		
Pin Names	Description	U.L.	Input I _{IH} /I _{IL}		
			Output I _{OH} /I _{OL}		
A _n , B _n	B _n Inputs		20 µA/–0.6 mA		
Ōn	Outputs	50/33.3	–1 mA/20 mA		

Function Table

Inp	uts	Outputs		
Α	в	ō		
L	L	Н		
L	Н	н		
н	L	н		
н	Н	L		

H = HIGH Voltage Level L = LOW Voltage Level

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Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature Ambient Temperature under Bias	–65°C to +150°C –55°C to +125°C				
Junction Temperature under Bias	–55°C to +175°C				
Plastic	–55°C to +150°C				
V _{CC} Pin Potential to					
Ground Pin	-0.5V to +7.0V				
Input Voltage (Note 4)	-0.5V to +7.0V				
Input Current (Note 4)	-30 mA to +5.0 mA				
Voltage Applied to Output					
in HIGH State (with $V_{CC} = 0V$)					
Standard Output	–0.5V to $V_{\rm CC}$				
TRI-STATE® Output	-0.5V to +5.5V				

Current Applied to Output

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in LOW State (Max) ESD Last Passing Voltage (Min) twice the rated $\rm I_{OL}$ (mA) $\rm 4000V$

Recommended Operating Conditions

Free Air Ambient Temperature						
Military	-55°C to +125°C					
Commercial	0°C to +70°C					
Supply Voltage						
Military	+4.5V to +5.5V					
Commercial	+4.5V to +5.5V					
Note 3: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.						
Note 4: Either voltage limit or current limit is sufficient to protect inputs.						

DC Electrical Characteristics

Symbol	Parameter		54F/74F			Units	Vcc	Conditions	
			Min	Тур	Max				
V _{T+}	Positive-going Threshold		1.5		2.0	V	5.0		
V _{T-}	Negative-going Threshold		0.7		1.1	V	5.0		
ΔV_T	Hysteresis (V _T ⁺ – V _T ⁻)		0.4			V	5.0		
V _{CD}	Input Clamp Diode Vol	tage			-1.2	V	Min	I _{IN} = -18 mA	
V _{он}	Output HIGH	54F 10% V _{CC}	2.5					I _{он} = –1 mA	
	Voltage	74F 10% V _{CC}	2.5			v	Min	I _{он} = –1 mA	
		74F 5% V _{CC}	2.7					I _{OH} = -1 mA	
V _{oL}	Output LOW	54F 10% V _{CC}			0.5	V	Min	I _{OL} = 20 mA	
	Voltage	74F 10% V _{CC}			0.5			I _{OL} = 20 mA	
н	Input HIGH	54F			20.0	μA	Max	V _{IN} = 2.7V	
	Current	74F			5.0				
BVI	Input HIGH Current	54F			100	μA	Max	V _{IN} = 7.0V	
	Breakdown Test	74F			7.0				
CEX	Output HIGH	54F			250	μA	Max	V _{OUT} = V _{CC}	
	Leakage Current	74F			50				
/ _{ID}	Input Leakage	74F	4.75			V	0.0	I _{ID} = 1.9 μA	
	Test							All Other Pins Grounded	
OD	Output Leakage	74F			3.75	μA	0.0	V _{IOD} = 150 mV	
	Circuit Current							All Other Pins Grounded	
IL	Input LOW Current				-0.6	mA	Max	V _{IN} = 0.5V	
os	Output Short-Circuit Co	urrent	-60		-150	mA	Max	V _{OUT} = 0V	
ссн	Power Supply Current				17.0	mA	Max	V _o = HIGH	
CCL	Power Supply Current				18.0	mA	Max	V _O = LOW	

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	lectrical Chara tion 0 for Waveforms an			;				
		74F T _A = +25°C			54F T _A , V _{CC} = Mil		74F T _A , V _{CC} = Com	
Symbol	Parameter	V _{CC} = +5.0V			C _L = 50 pF		C _L = 50 pF	
		C _L = 50 pF		-				
		Min	Тур	Max	Min	Max	Min	Max

4.0

5.0

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Fig.

No.

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Units

ns

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Ordering Information

 $\mathsf{A}_{\mathsf{n}},\,\mathsf{B}_{\mathsf{n}}$ to $\overline{\mathsf{O}}_{\mathsf{n}}$

Propagation Delay

t_{PLH}

t_{PHL}

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The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

10.5

12.5

2.0

4.5

13.0

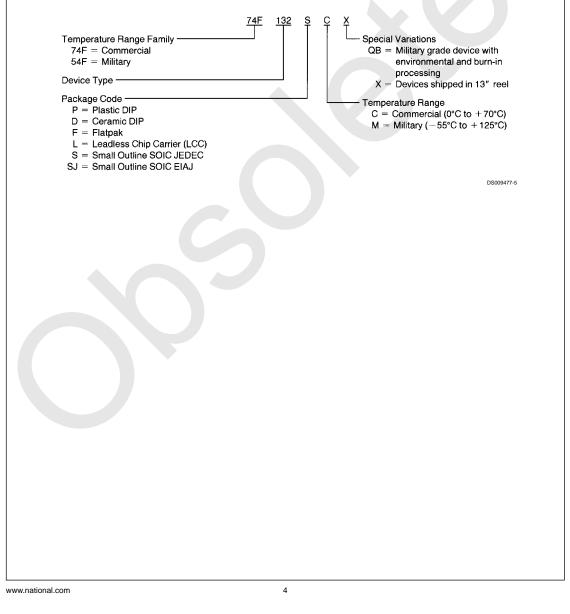
16.0

3.5

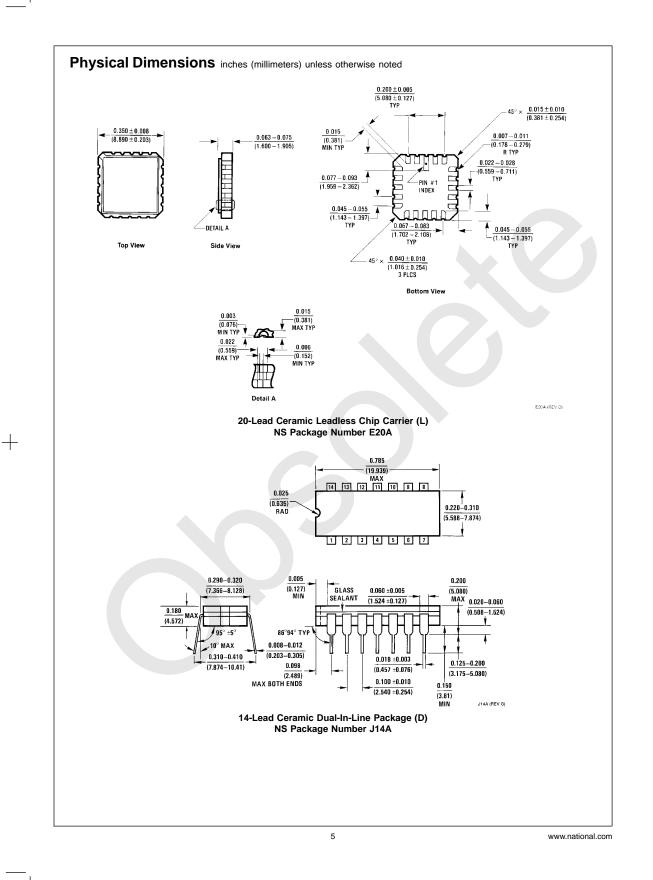
5.0

12.0

13.0

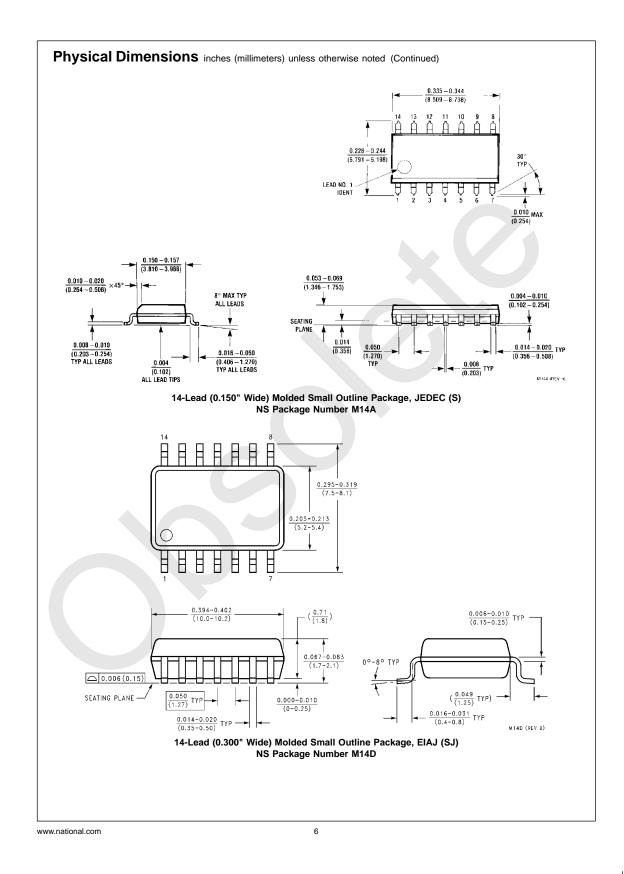


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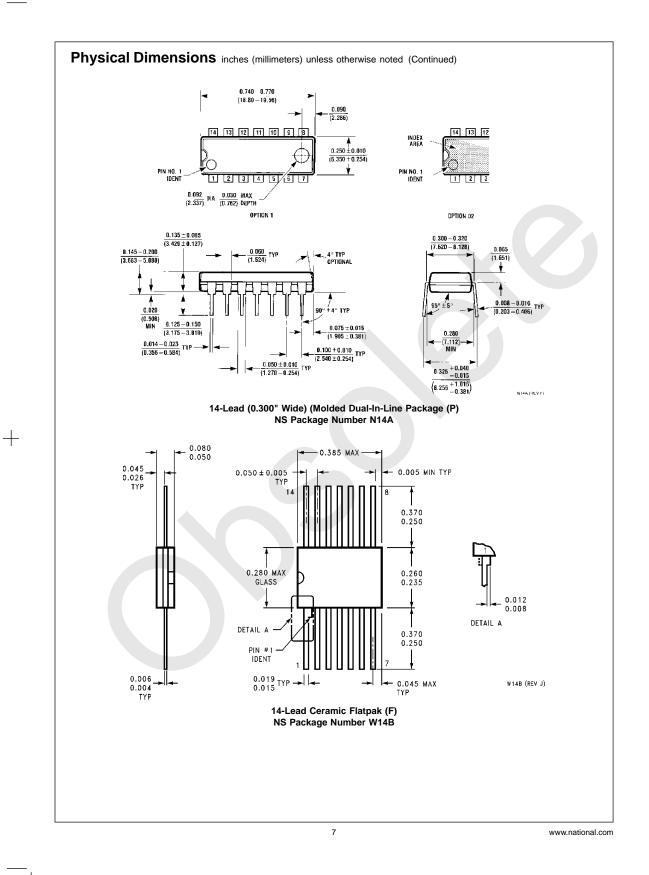
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